

SiC JFET Division

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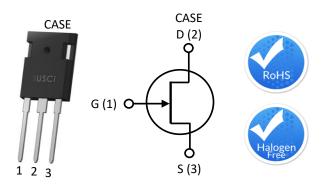
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Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 650 V, 25 mohm UJ3N065025K3S

Datasheet

Description

United Silicon Carbide, Inc offers the high-performance G3 SiC normally-on JFET transistors. This series exhibits ultra-low on resistance ($R_{DS(ON)}$) and gate charge (Q_G) allowing for low conduction and switching loss. The device normally-on characteristics with low $R_{DS(ON)}$ at V_{GS} = 0 V is also ideal for current protection circuits without the need for active control, as well as for cascode operation.



Part Number	Package	Marking
UJ3N065025K3S	TO-247-3L	UJ3N065025K3S

Features

- \bullet Typical on-resistance $R_{\text{DS(on),typ}}$ of $25 m\Omega$
- Voltage controlled
- Maximum operating temperature of 175°C
- Extremely fast switching not dependent on temperature
- Low gate charge
- Low intrinsic capacitance
- RoHS compliant

Typical Applications

- Over current protection circuits
- DC-AC inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units	
Drain-source voltage	V _{DS}		650	V	
Gate-source voltage	V	DC	-20 to +3	V	
	V_{GS}	AC ⁽¹⁾	-20 to +20	V	
Continuous drain current (2)		T _C = 25°C	85	А	
	ID	T _C = 100°C	62	Α	
Pulsed drain current (3)	I _{DM}	T _C = 25°C	250	Α	
Power dissipation	P _{tot}	T _C =25°C	441	W	
Maximum junction temperature	T _{J,max}		175	°C	
Operating and storage temperature	T _J , T _{STG}		-55 to 175	°C	
Max. lead temperature for soldering, 1/8" from case for 5 seconds	T _L		250	°C	

- (1) +20V AC rating applies for turn-on pulses <200ns applied with external $R_G > 1\Omega$.
- (2) Limited by T_{J,max}
- (3) Pulse width t_p limited by T_{J,max}



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Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Units
ratanietei		rest conditions	Min	Тур	Max	Ullits
Drain-source breakdown voltage	BV _{DS}	V_{GS} = - 20V, I_D =1mA	650			V
Total drain leakage current	I _D	$V_{DS} = 650V$, $V_{GS} = -20V$, $T_{J} = 25$ °C		10	60	- μΑ
		$V_{DS} = 650V$, $V_{GS} = -20V$, $T_{J} = 175$ °C		40		
Total gate leakage current	I _G	V _{GS} =-20V, T _j =25°C		10	100	μА
		V _{GS} =-20V, T _j =175°C		38		
Drain-source on-resistance	R _{DS(on)}	$V_{GS}=2V, I_{D}=20A,$ $T_{J}=25^{\circ}C$		22		mΩ
		V_{GS} =0V, I_D =20A, T_J = 25°C		25	33	
		$V_{GS}=2V, I_{D}=20A,$ $T_{J}=175^{\circ}C$		38		
		V_{GS} =0V, I_{D} =20A, T_{J} = 175°C		43		
Gate threshold voltage	V _{G(th)}	$V_{DS} = 5V, I_{D} = 70 \text{mA}$	-14	-11.5	-6	V
Gate resistance	R_{G}	f = 1MHz, open drain		2.5		Ω

Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 650 V, 25 mohm| UJ3N065025K3S

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Typical Performance - Dynamic

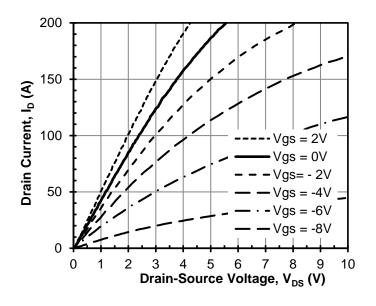
Doromotor	symbol	Test Conditions	Value			Units		
Parameter	Syllibol	rest conditions	Min	Тур	Max	Ullits		
Input capacitance	C _{iss}	V _{DS} = 100V,		2360		pF		
Output capacitance	C _{oss}	V _{GS} = -20V,		290				
Reverse transfer capacitance	C _{rss}	f = 100kHz		282				
Effective output capacitance, energy related	C _{oss(er)}	$V_{DS} = 0V \text{ to } 400V,$ $V_{GS} = -20V$		210		pF		
Total gate charge	Q_{G}	V 400V I 60A		240		nC		
Gate-drain charge	Q_{GD}	V_{DS} =400V, I_{D} = 60A,		134				
Gate-source charge	Q_{GS}	V _{GS} =-18V to 0V		24				
Turn-on delay time	t _{d(on)}	$V_{DS}=400V, I_{D}=60A,$ Gate Driver =-18V to 0V, $R_{G,EXT}=1\Omega,$ Inductive Load, $FWD: UJ3D06530TS$ $T_{J}=25^{\circ}C$		11		ns - - - -		
Rise time	t _r			64				
Turn-off delay time	t _{d(off)}			43				
Fall time	t _f			44				
Turn-on energy	E _{ON}			740				
Turn-off energy	E _{OFF}			818				
Total switching energy	E _{TOTAL}			1558				
Turn-on delay time	t _{d(on)}	$V_{DS}=400V,\ I_{D}=60A,$ Gate Driver =-18V to 0V, $R_{G,EXT}=1\Omega,$ Inductive Load, $FWD:\ UJ3D06530TS$ $T_{J}==150^{\circ}C$		11		- ns		
Rise time	t _r			62				
Turn-off delay time	t _{d(off)}			38				
Fall time	t _f			41				
Turn-on energy	E _{ON}			663				
Turn-off energy	E _{OFF}			750		μͿ		
Total switching energy	E _{TOTAL}			1413				

Thermal Characteristics

Parameter	symbol	Test Conditions	Value			Units
rarameter			Min	Тур	Max	Offics
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.26	0.34	°C/W



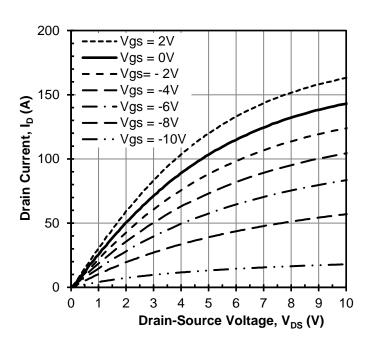
Typical Performance Diagrams

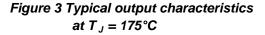


200 150 Drain Current, I_D (A) 100 - Vgs = 2V Vgs = 0VVgs= - 2V 50 Vgs = -4V- Vgs = -6V Vgs = -8V3 5 6 8 10 Drain-Source Voltage, V_{DS} (V)

Figure 1 Typical output characteristics at $T_J = -55$ °C

Figure 2 Typical output characteristics at $T_J = 25$ °C





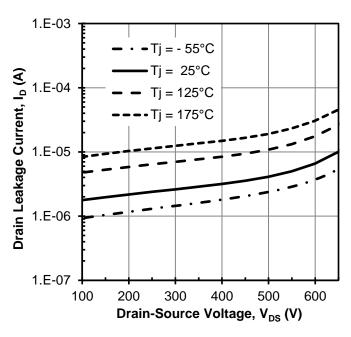


Figure 4 Typical drain-source leakage at $V_{GS} = -20V$

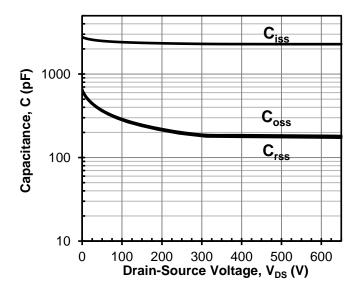


Figure 5 Typical capacitances at 100kHz and $V_{GS} = -20V$

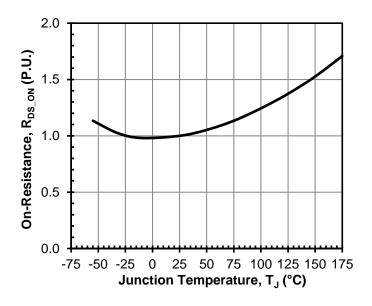


Figure 7 Normalized on-resistance vs. temperature at $V_{GS} = 0V$ and $I_D = 20A$

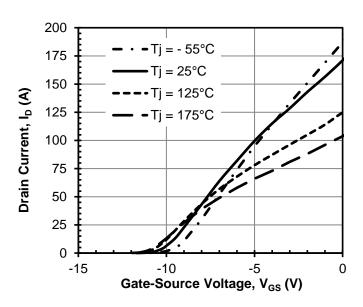


Figure 6 Typical transfer characteristics at $V_{DS} = 5V$

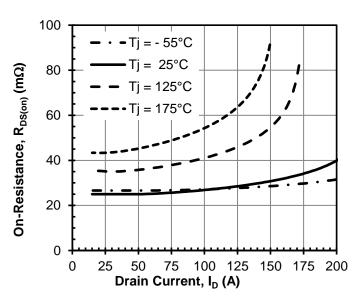


Figure 8 Typical drain-source on-resistance at $V_{GS} = 0V$



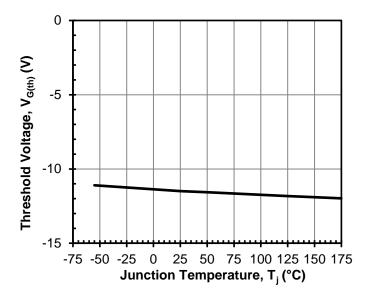


Figure 9 Threshold voltage vs. Tj at $V_{DS} = 5V$ and $I_D = 70mA$

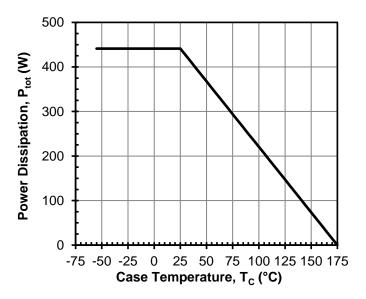


Figure 11 Total power Dissipation

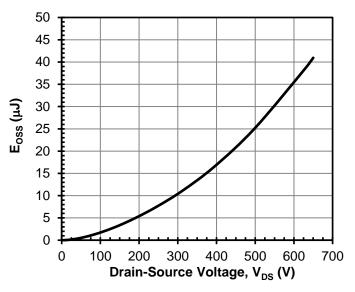


Figure 10 Typical stored energy in C_{OSS} at $V_{GS} = -20V$

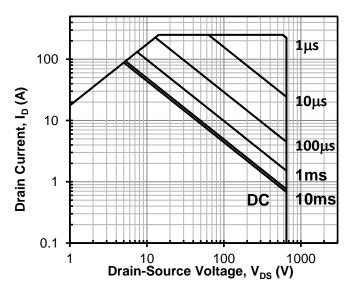


Figure 12 Safe operation area $T_c = 25$ °C, Parameter t_p



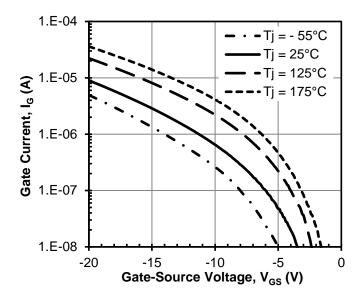


Figure 13 Typical gate leakage current at $V_{DS} = 0V$

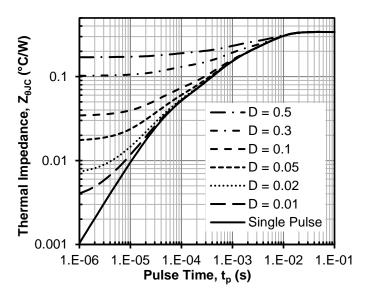


Figure 15 Maximum transient thermal impedance

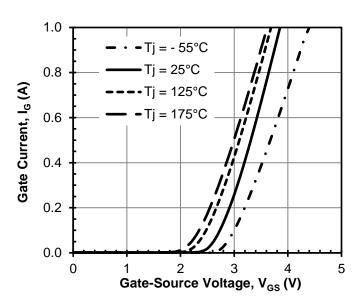


Figure 14 Typical gate forward current at $V_{DS} = 0V$

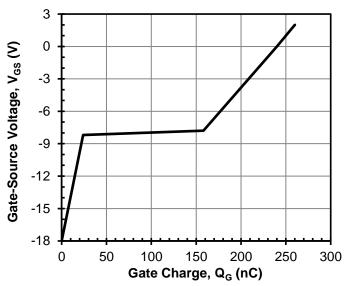
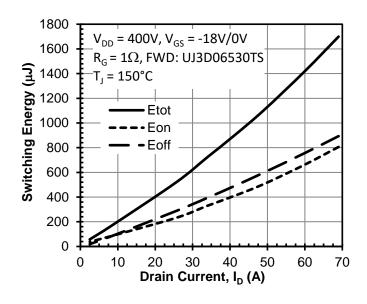


Figure 16 Typical gate charge at $V_{DS} = 400V$ and $I_D = 60A$





4500 $V_{DD} = 400V, V_{GS} = -18V/0V$ 4000 I_D =60A, T_I = 150°C Switching Energy (µJ 3500 FWD: UJ3D06530TS - Etot 3000 Eon 2500 Eoff 2000 1500 1000 500 0 2 10 8 0 Gate Resistor, $R_{G}(\Omega)$

Figure 17 Clamped inductive switching energy vs. drain current at $T_J = 150$ °C

Figure 18 Clamped inductive switching energy vs. gate resistor R_G

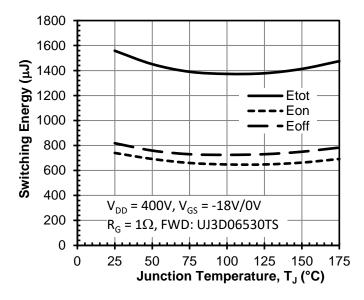


Figure 19 Clamped inductive switching energy vs. junction temperature at $I_D = 60A$

Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 650 V, 25 mohm | UJ3N065025K3S

Datasheet

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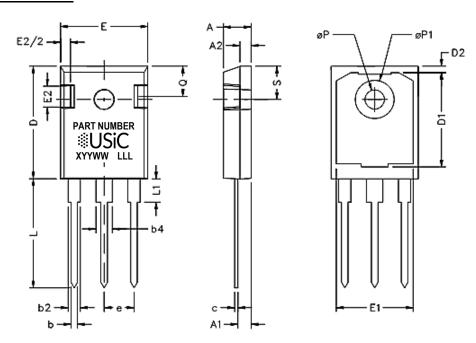
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TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PACKAGE OUTLINE

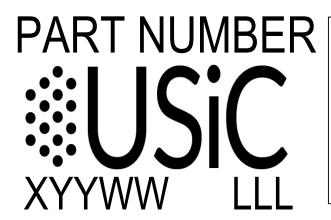


SYM	INC	HES	MILLIN	METERS
	MIN	MAX	MIN	MAX
А	0.185	0.209	4.699	5.309
A1	0.087	0.102	2.21	2.61
A2	0.059	0.098	1.499	2.489
b	0.039	0.055	0.991	1.397
b2	0.065	0.094	1.651	2.388
b4	0.102	0.135	2.591	3.429
С	0.015	0.035	0.381	0.889
D	0.819	0.845	20.803	21.463
D1	0.515	-	13.081	-
D2	0.02	0.053	0.508	1.346
E	0.61	0.64	15.494	16.256
е	0.214	0.214 BSC		BSC
E1	0.53	-	13.462	-
E2	0.135	0.157	3.429	3.988
L	0.78	0.8	19.812	20.32
L1	-	0.177	ı	4.496
ØΡ	0.14	0.144	3.556	3.658
ØP1	0.278	0.291	7.061	7.391
Q	0.212	0.244	5.385	6.198
S	0.243	3 BSC	6.17	BSC



TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PART MARKING



PART NUMBER = REFER TO
DS PN DECODER FOR DETAILS

X = ASSEMBLY SITE

YY = YEAR

WW = WORK WEEK

LLL = LOT ID

PACKING TYPE

ANTI-STATIC TUBE

QUANTITY / TUBE : 30 UNITS

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